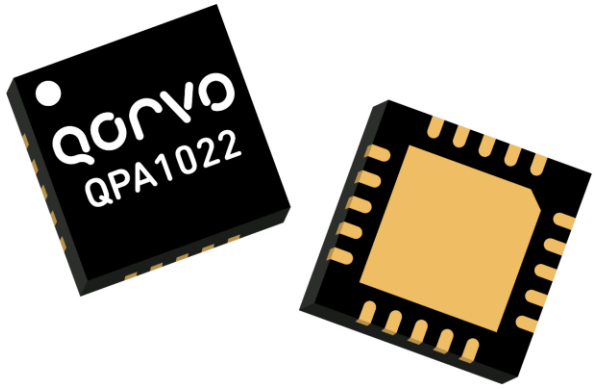
QPA1022

8.5 – 11 GHz 4 W GaN Power Amplifier

Product Overview

Qorvo's QPA1022 is a packaged, high performance power amplifier fabricated on Qorvo's production 0.15 um GaN on SiC process (QGaN15). Covering 8.5 – 11.0 GHz, the QPA1022 provides > 4 W of saturated output power and 24.5 dB of large-signal gain while achieving 45% power-added efficiency.

Packaged in a small 4 x 4 mm plastic overmold QFN, the QPA1022 is matched to 50Ω with integrated DC blocking capacitors at RF output and DC grounded input port. It also has a built-in power detector for system RF power checking. With a compact dimension, it can support tight lattice spacing requirements for phased array radar applications. It is also an ideal component to support test instrumentation and commercial communication systems.

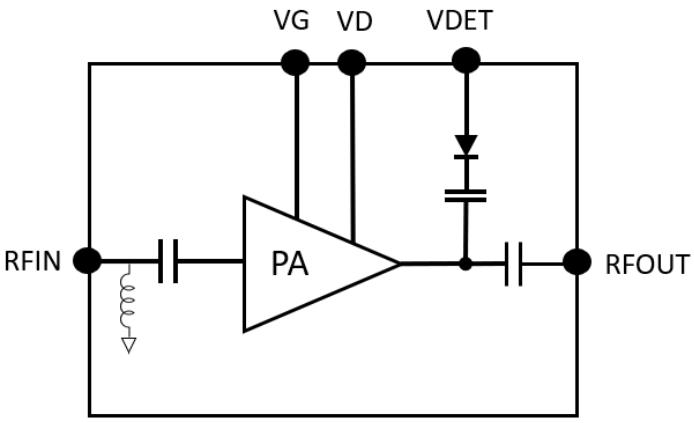


Key Features

- Frequency Range: 8.5 – 11 GHz
- P_{SAT} (P_{IN}=12 dBm): 36.5 dBm
- PAE (P_{IN}=12 dBm): 45 %
- Power Gain (P_{IN}= 12 dBm): 24.5 dB
- Small Signal Gain: 32 dB
- Bias: V_D = 22 V, I_{DQ} = 180 mA
- Package Dimensions: 4 x 4 x 0.85 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

Functional Block Diagram



Applications

- Radar
- Electronic Warfare
- Communications

Ordering Information

Part No.	Description
QPA1022	QPA1022 Amplifier, Shipping Tray, Qty 50
QPA1022TR	QPA1022 Amplifier, Tape & Reel 7", Qty 250
QPA1022EVB0	QPA1022 Evaluation Board, Qty 1

Absolute Maximum Ratings

Parameter	Value / Range	Units
Drain Voltage (V_D)	28	V
Gate Voltage Range (V_G)	-5 to 0	V
Drain Current (I_D)	600	mA
Gate Current (I_G)	10	mA
Input Power (P_{IN}), 3:1 VSWR, V_D=22 V, I_{DQ}=180 mA, 85 °C	27	dBm
Storage Temperature	-55 to +150	°C

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Value / Range	Units
Drain Voltage (V_D)	22	V
Drain Current (I_{DQ})	180	mA
Operating Temperature	− 40 to + 85	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

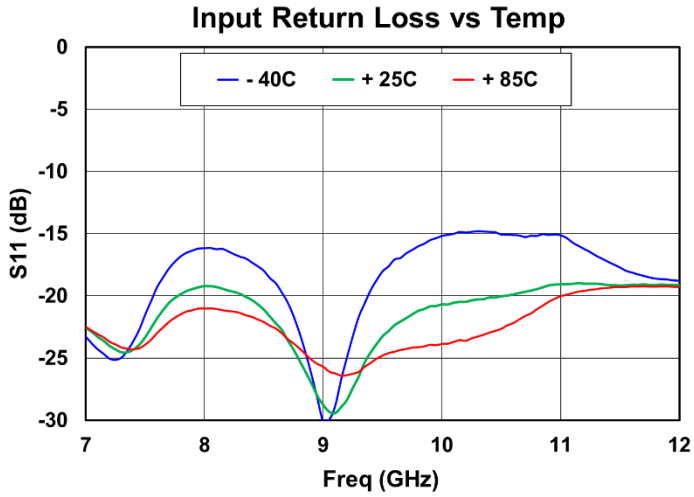
Test conditions unless otherwise noted: Temp = 25 °C, V_D = 22 V, I_{DQ} = 180 mA. Data de-embedded to the reference planes.

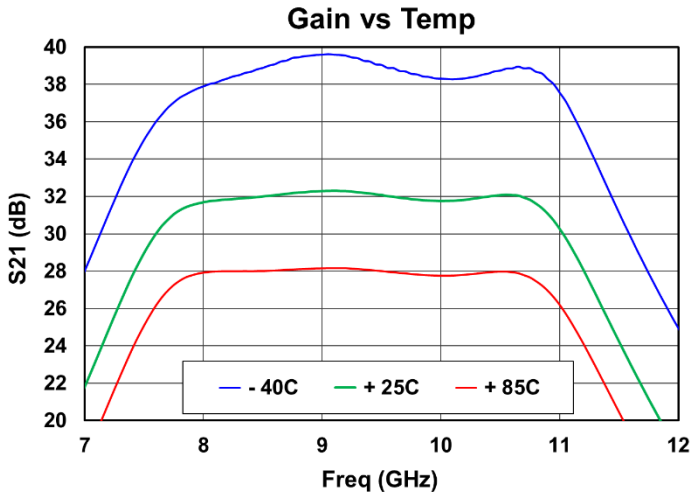
Parameter	Min	Typ	Max	Units
Operational Frequency	8.5		11	GHz
Output Power (Pulse and CW, P_{IN}=12 dBm)		36.5		dBm
Power Added Efficiency (Pulse and CW, P_{IN}= 12 dBm)		45		%
Large Signal Gain (Pulse and CW, P_{IN}=12 dBm)		24.5		dB
Small Signal Gain		32		dB
Input Return Loss		20		dB
Output Return Loss		10		dB
Harmonic Suppression (CW @P_{OUT} = 36 dBm, $2f_0$)		25		dBc
P_{OUT} Temp. Coeff. (P_{IN} = 12 dBm)		−0.01		dB/°C
Small Signal Gain Temp. Coefficient		−0.084		dB/°C

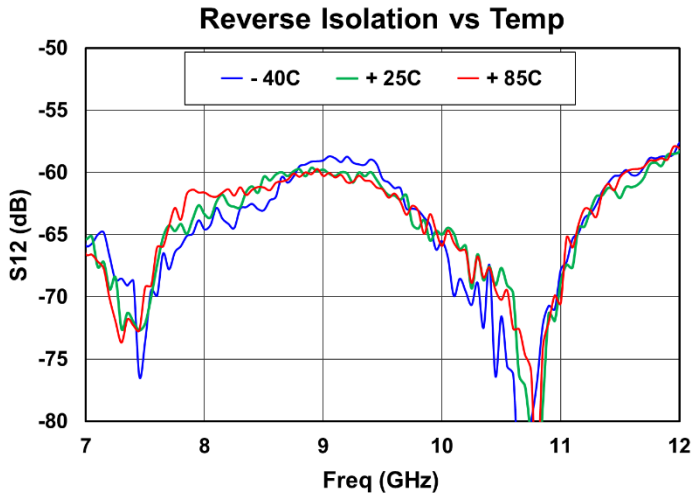
Note: For pulse power, Pulse Width = 100 uS, Duty Cycle = 10%

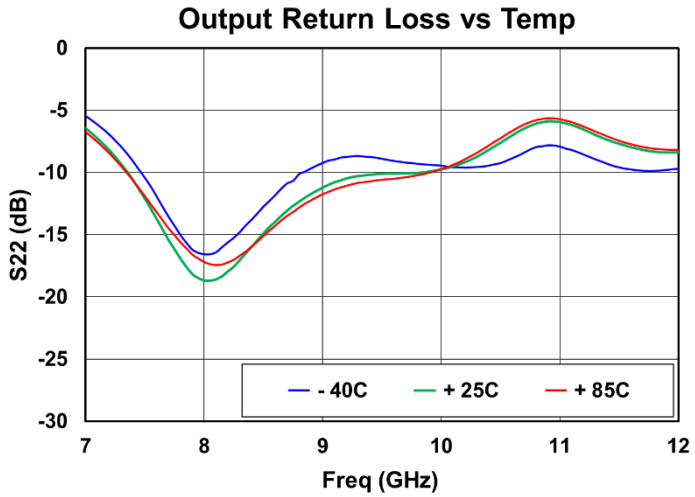
Performance Plots – Small Signal

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Temperature = + 25 °C





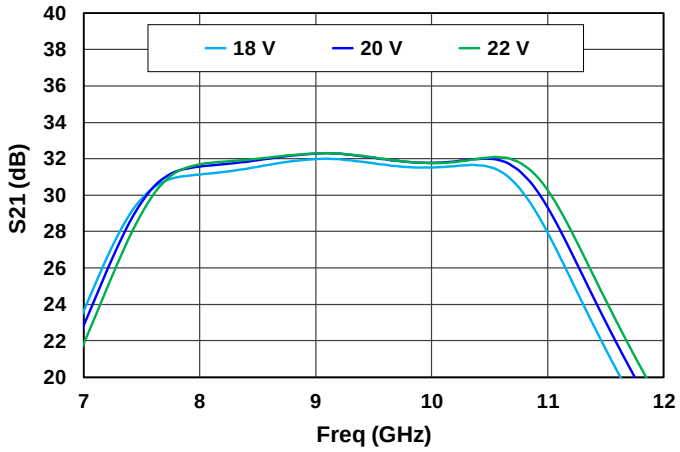




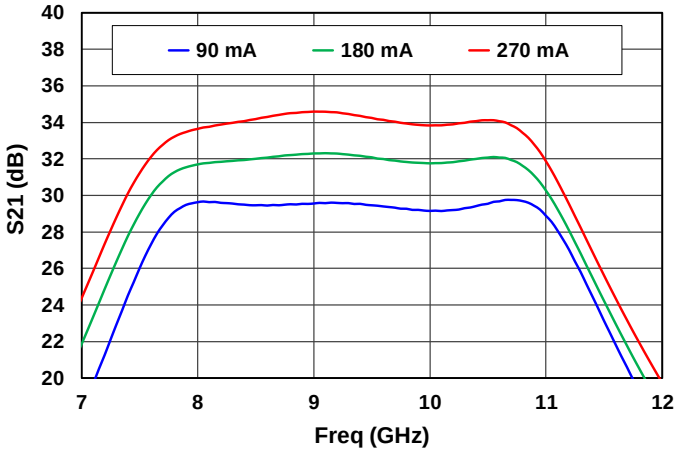
Performance Plots – Small Signal

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Temperature = + 25 °C

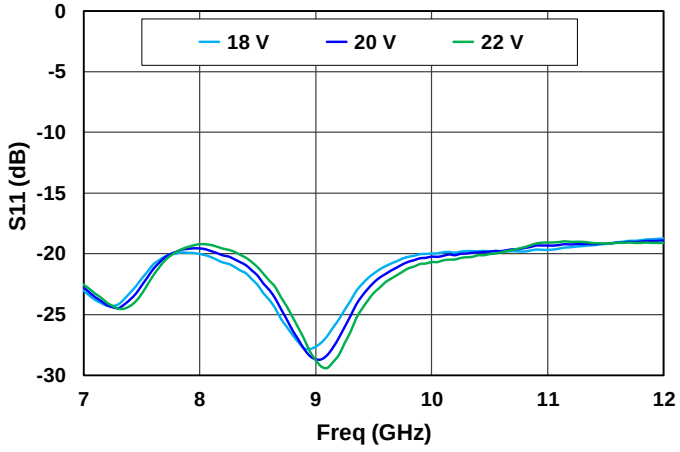
Gain vs Voltage



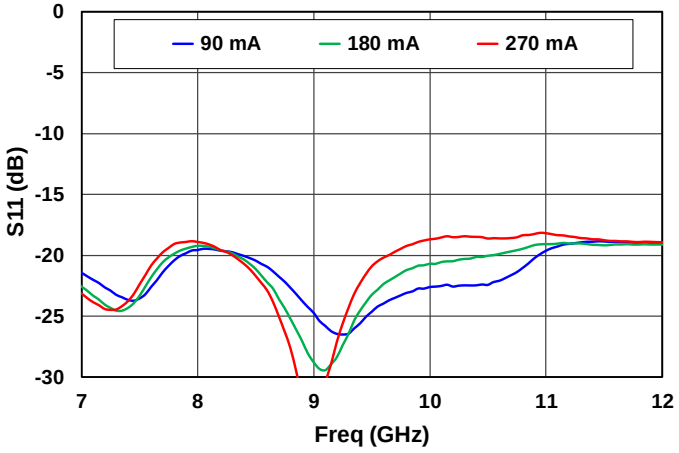
Gain vs Current



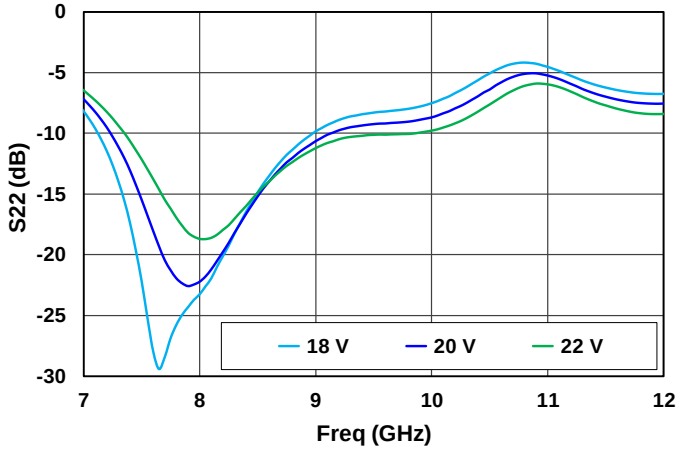
Input Return Loss vs Voltage



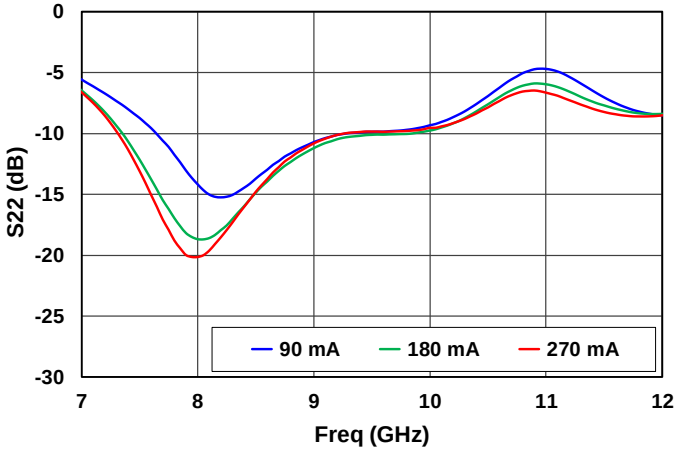
Input Return Loss vs Current



Output Return Loss vs Voltage



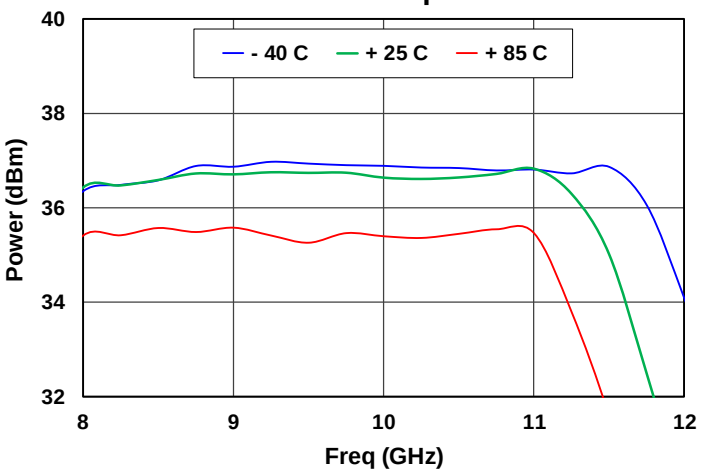
Output Return Loss vs Current



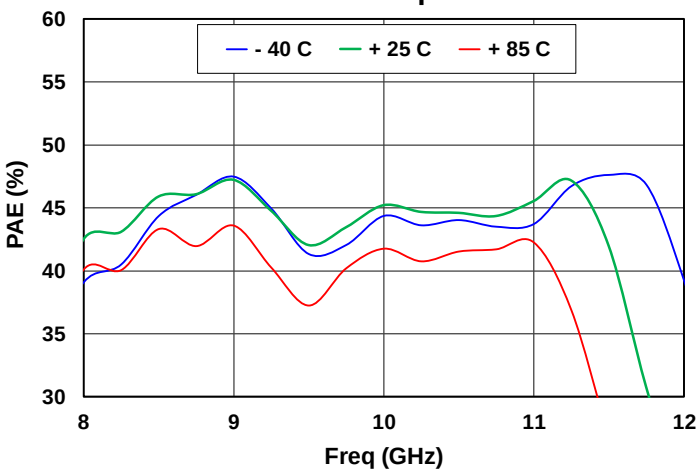
Performance Plots – Large Signal, Pulse

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Pin = 12 dBm, Pulse Width = 100 uS, DC = 10%, Temp = + 25 °C

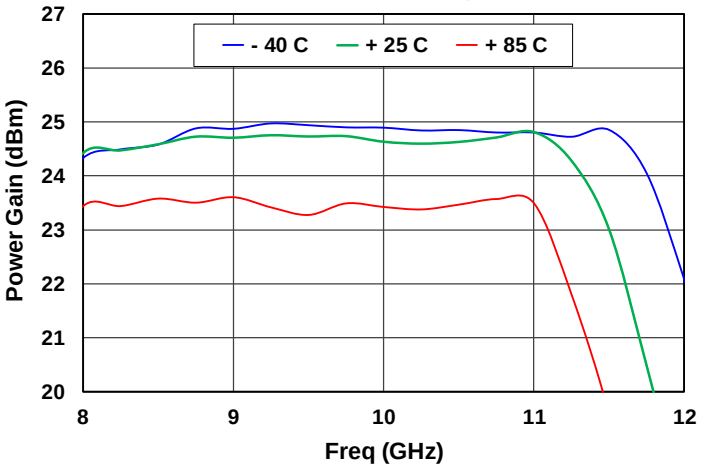
Power vs Temperature



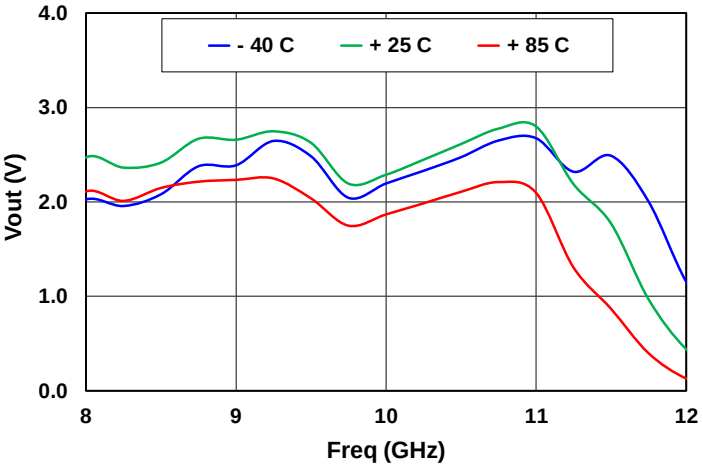
PAE vs Temperature



Power Gain vs Temperature

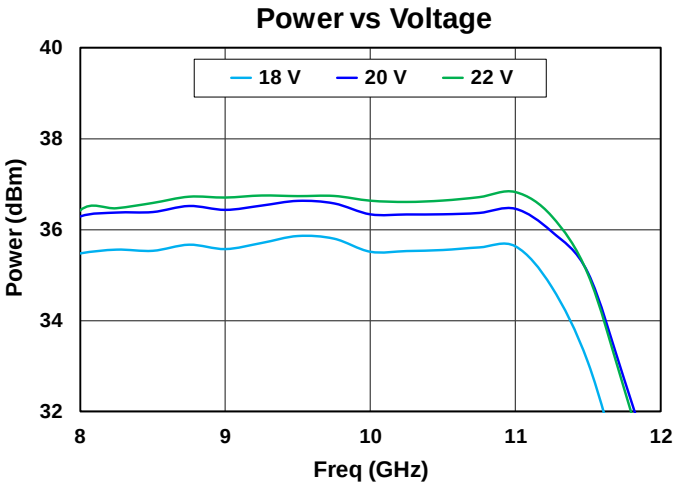


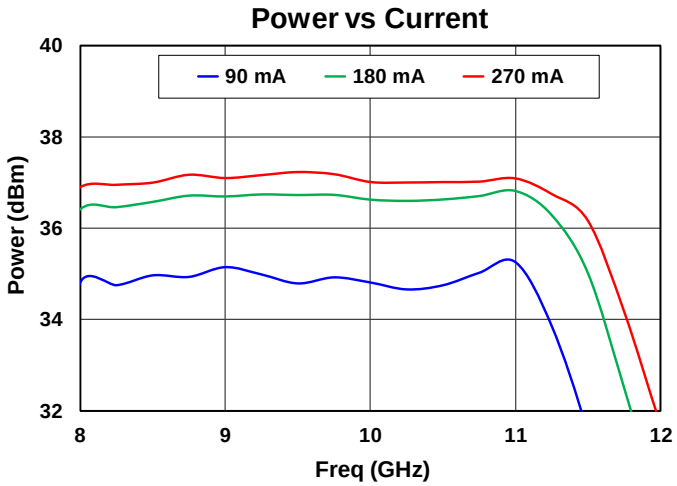
Power Detector Voltatge vs Temp

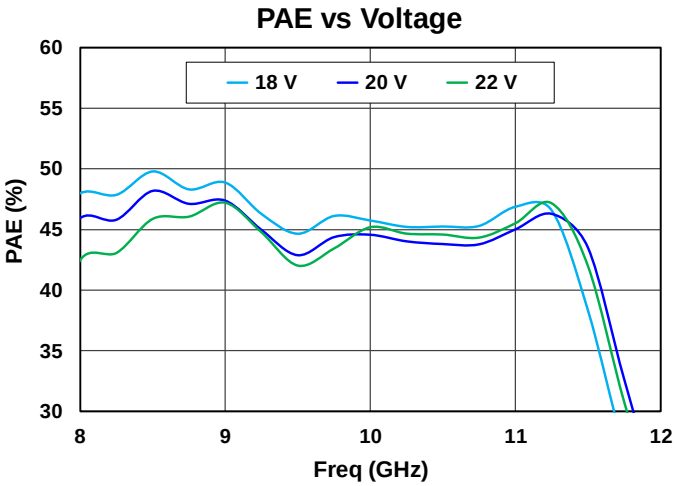


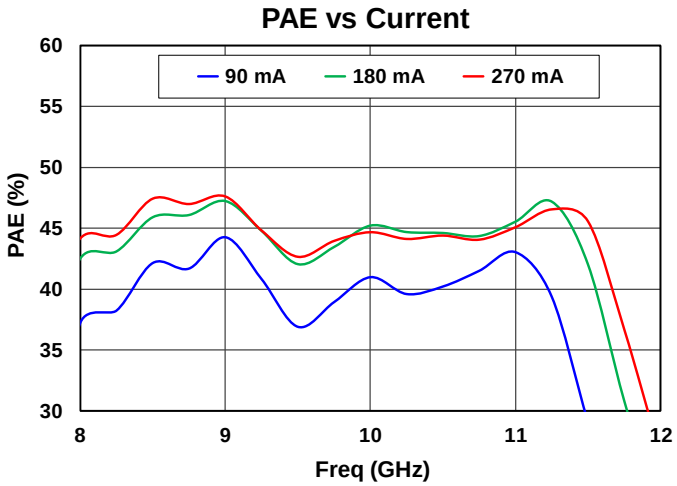
Performance Plots – Large Signal, Pulse

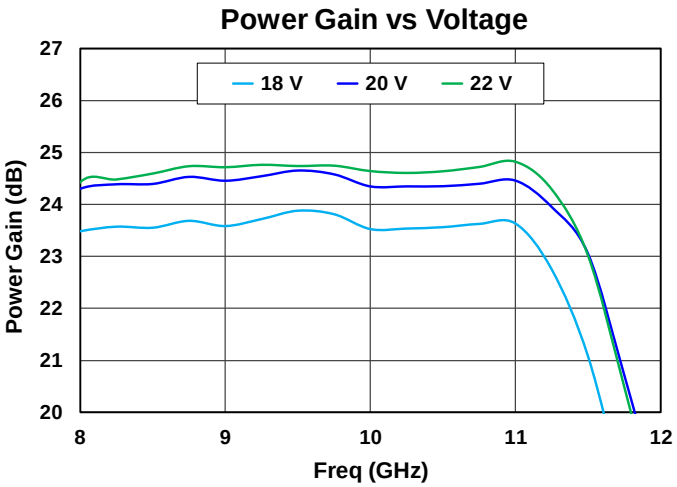
Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Pin = 12 dBm, Pulse Width = 100 uS, DC = 10%, Temp = + 25 °C

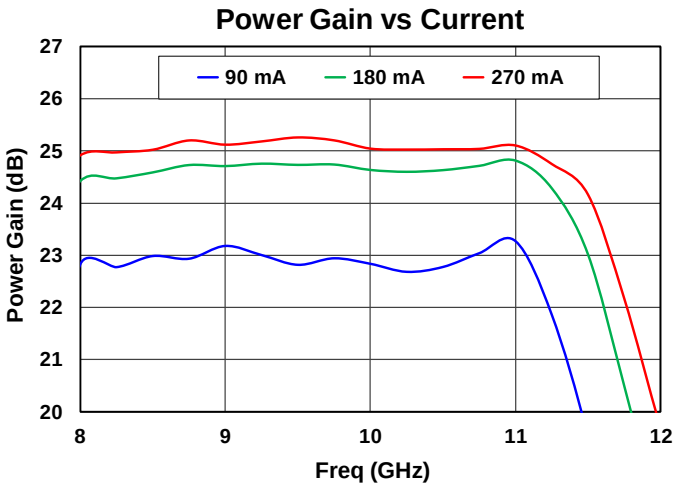








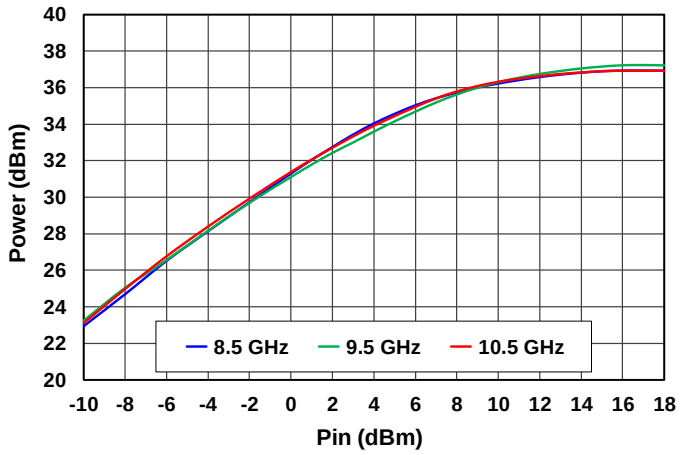




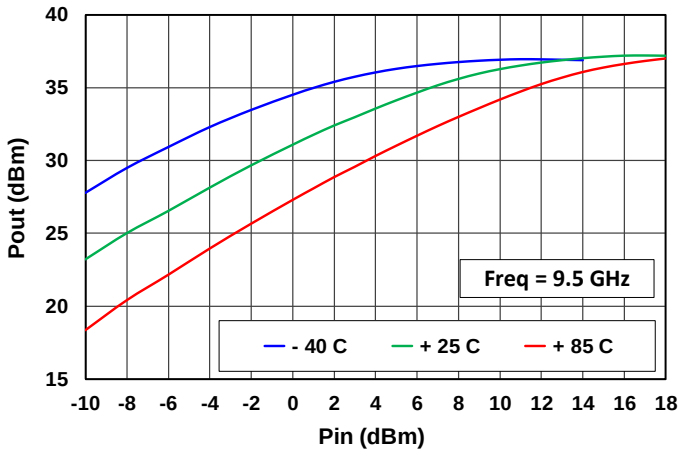
Performance Plots – Large Signal, Pulse

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Pulse Width = 100 uS, DC = 10%, Temp = + 25 °C

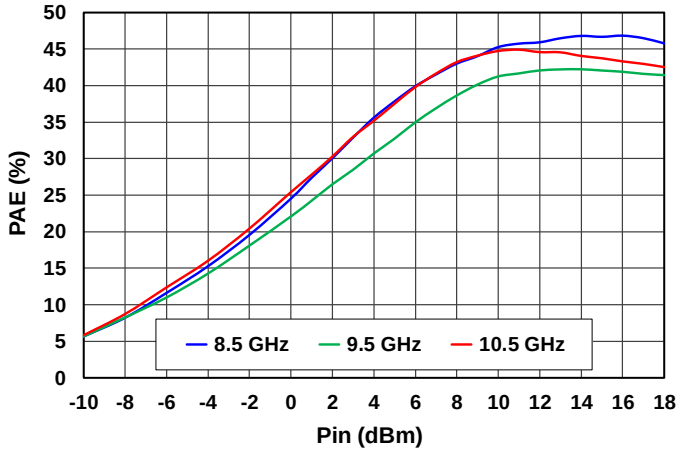
Power vs Pin



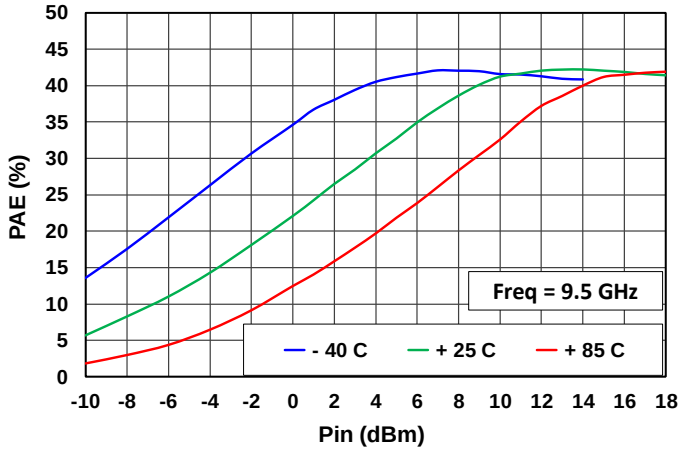
Pout vs Pin vs Temp



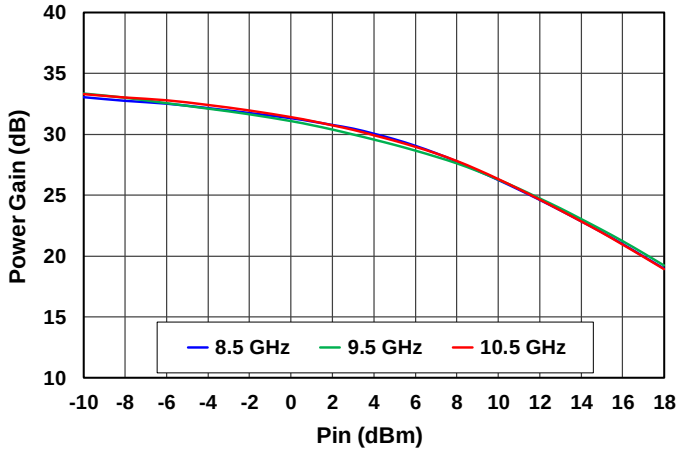
PAE vs Pin



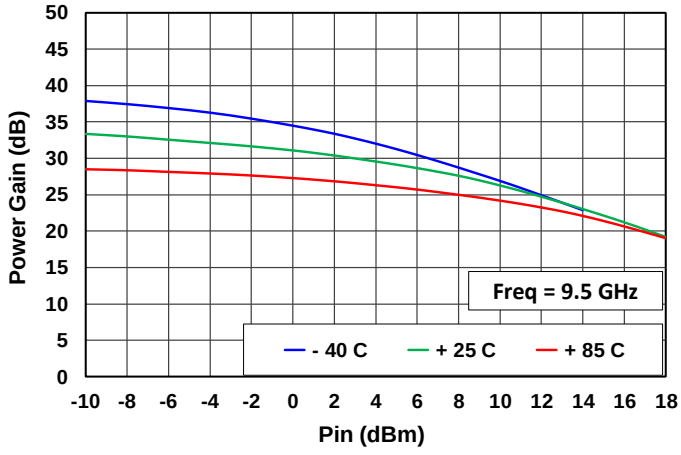
PAE vs Pin vs Temp



Power Gain vs Pin

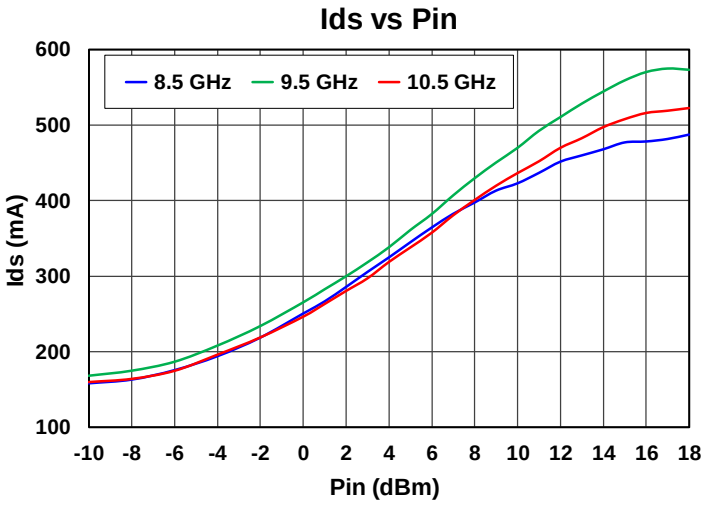


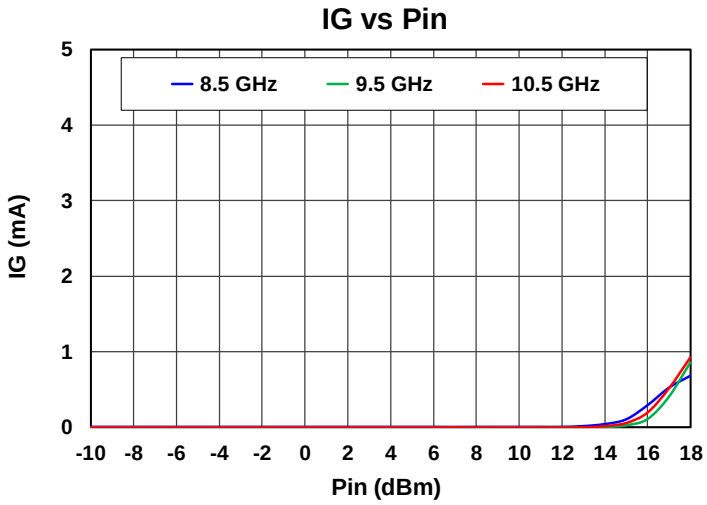
Power Gain vs Pin vs Temp

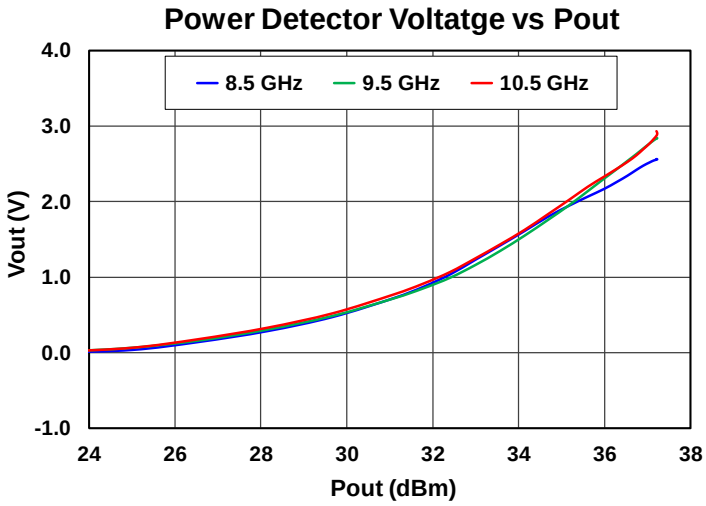


Performance Plots – Large Signal, Pulse

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Pulse Width = 100 uS, DC = 10%, Temp = + 25 °C

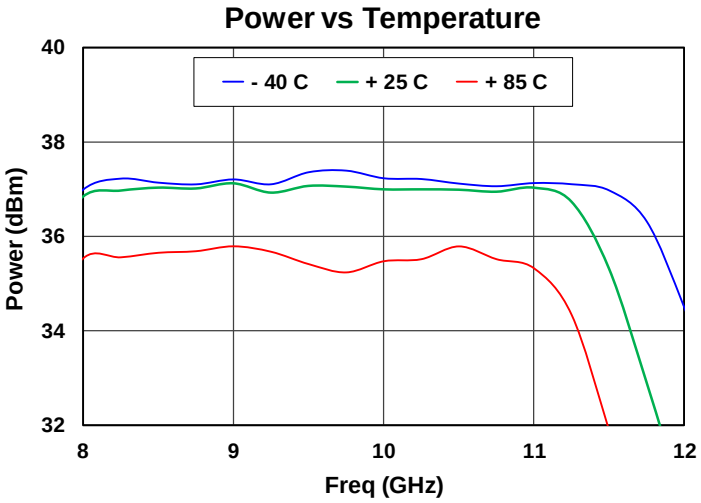


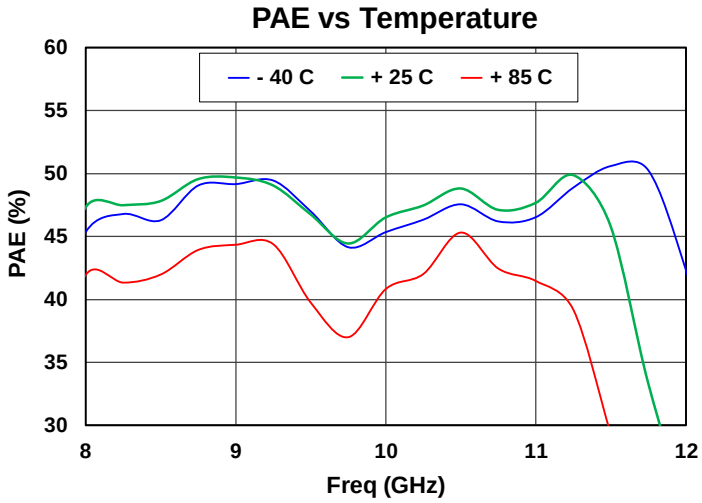


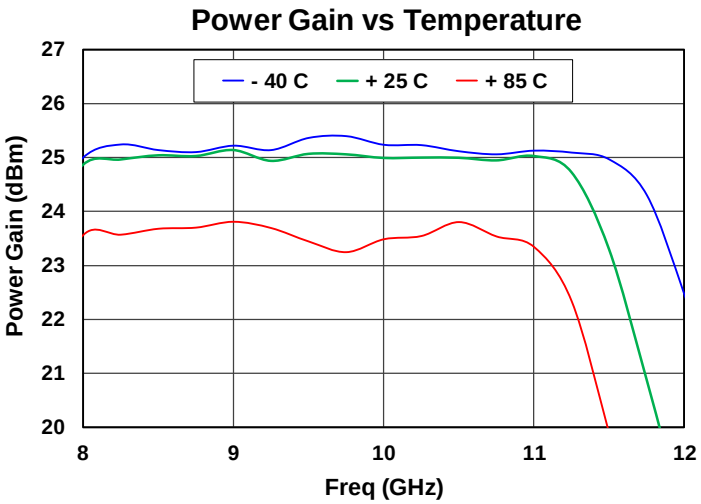


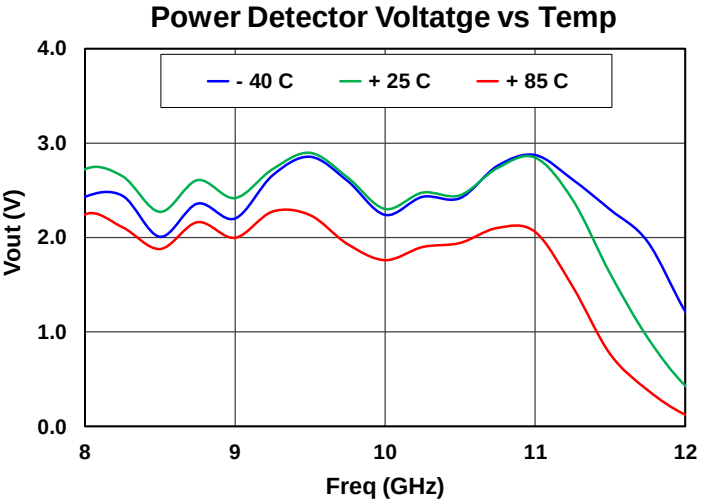
Performance Plots – Large Signal, CW

Test conditions unless otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Pin = 12 dBm, Temperature = + 25 °C





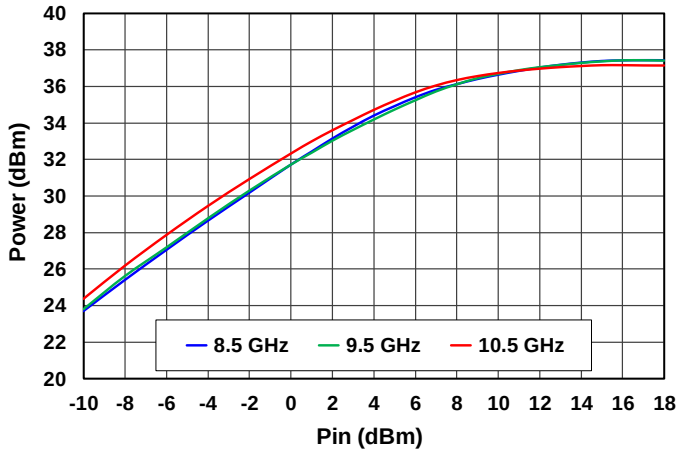




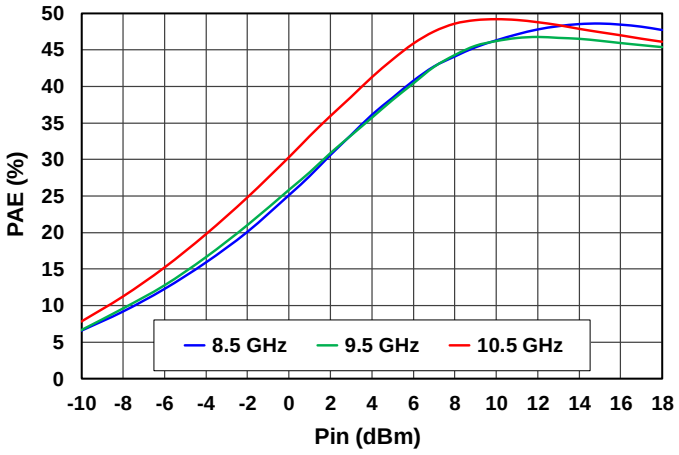
Performance Plots – Large Signal, CW

Test conditions otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Temperature = + 25 °C

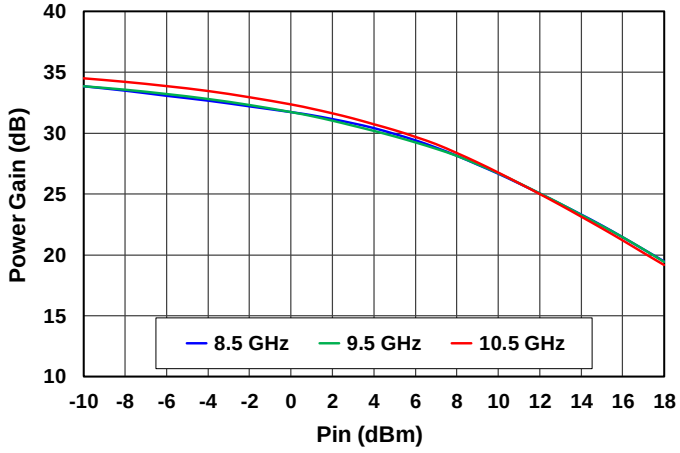
Power vs Pin



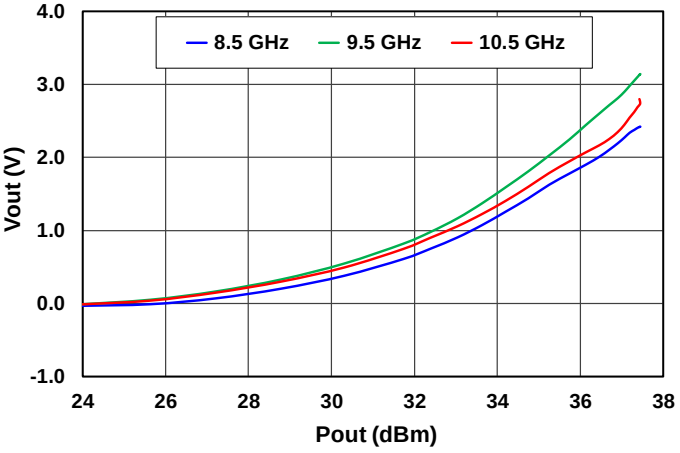
PAE vs Pin



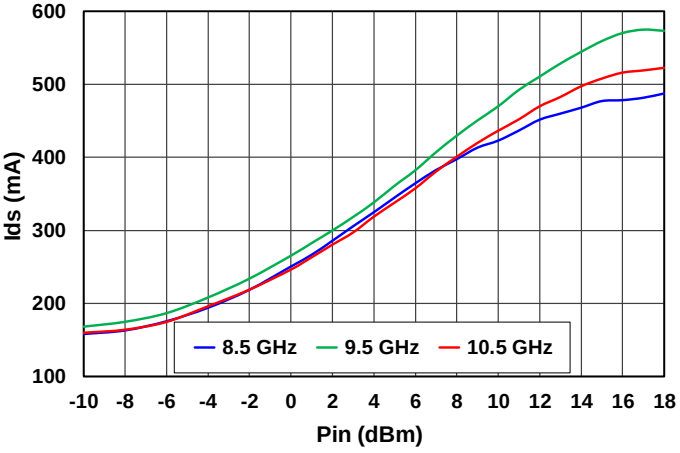
Power Gain vs Pin



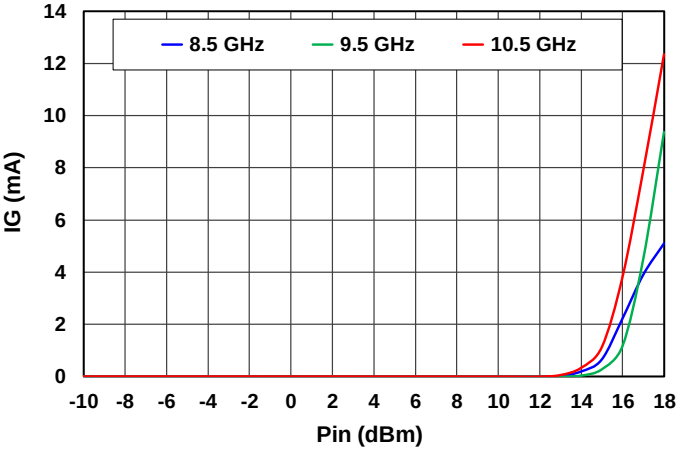
Power Detector Voltatge vs Pout



Ids vs Pin

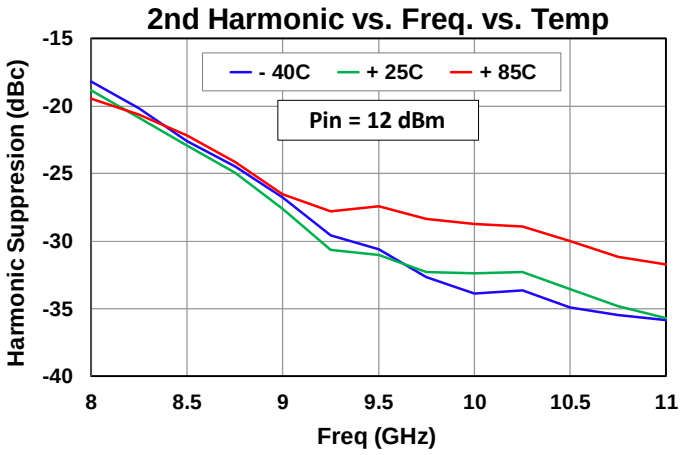


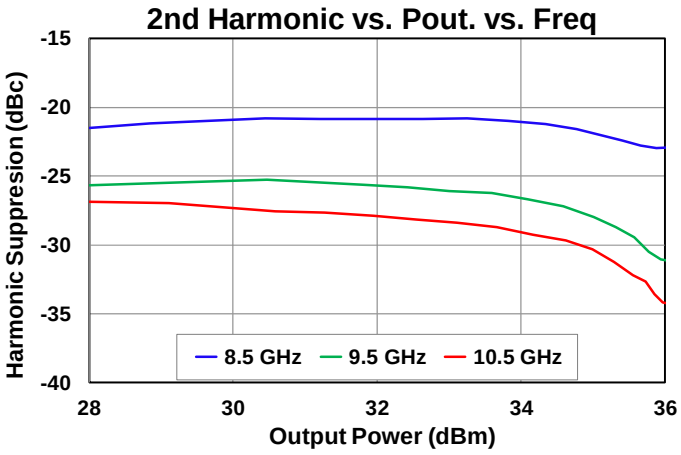
IG vs Pin

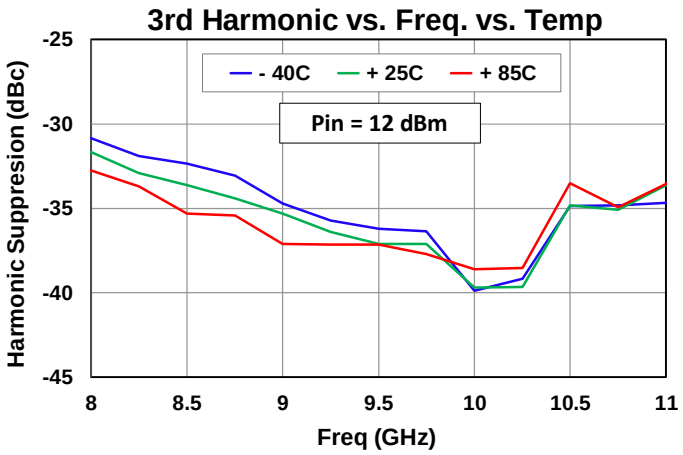


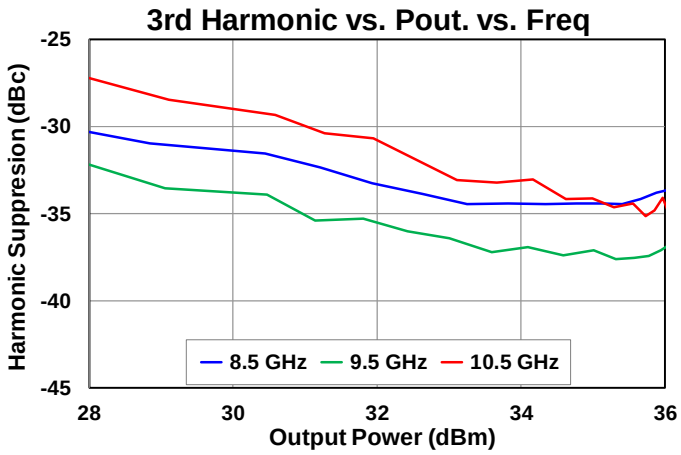
Performance Plots – Harmonic Suppressions, CW

Test conditions otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, Temperature = + 25 °C









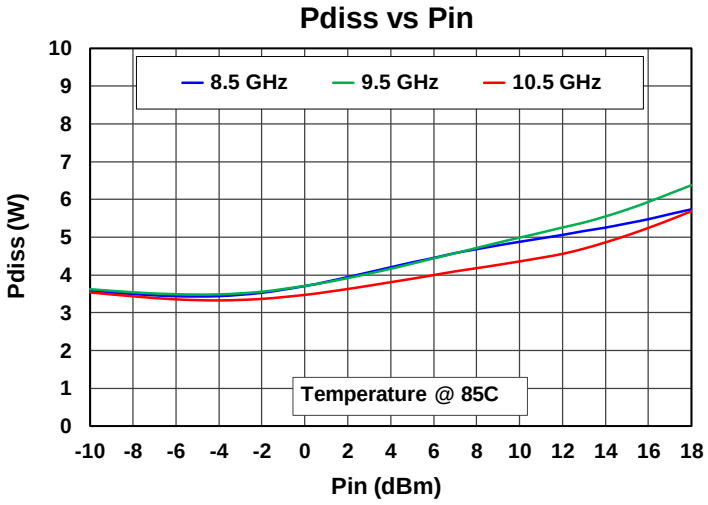
Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) (1)	T_{base} = 85 ºC, V_D = 22 V, I_{DQ} = 180 mA, P_{DISS} = 3.96 W, CW, No RF (quiescent DC operation)	10.9	ºC/W
Channel Temperature, T_{CH} (No RF) (2)		128.2	ºC
Thermal Resistance (θ_{JC}) (1)	T_{base} = 85 ºC, V_D = 22 V, I_{DQ} = 180 mA, CW Freq = 9.5 GHz, I_{D_Drive} = 0.514 A, P_{IN} = 18 dBm, P_{OUT} = 37.0 dBm, P_{DISS} = 6.4 W	8.5	ºC/W
Channel Temperature, T_{CH} (Under RF) (2)		139.4	ºC

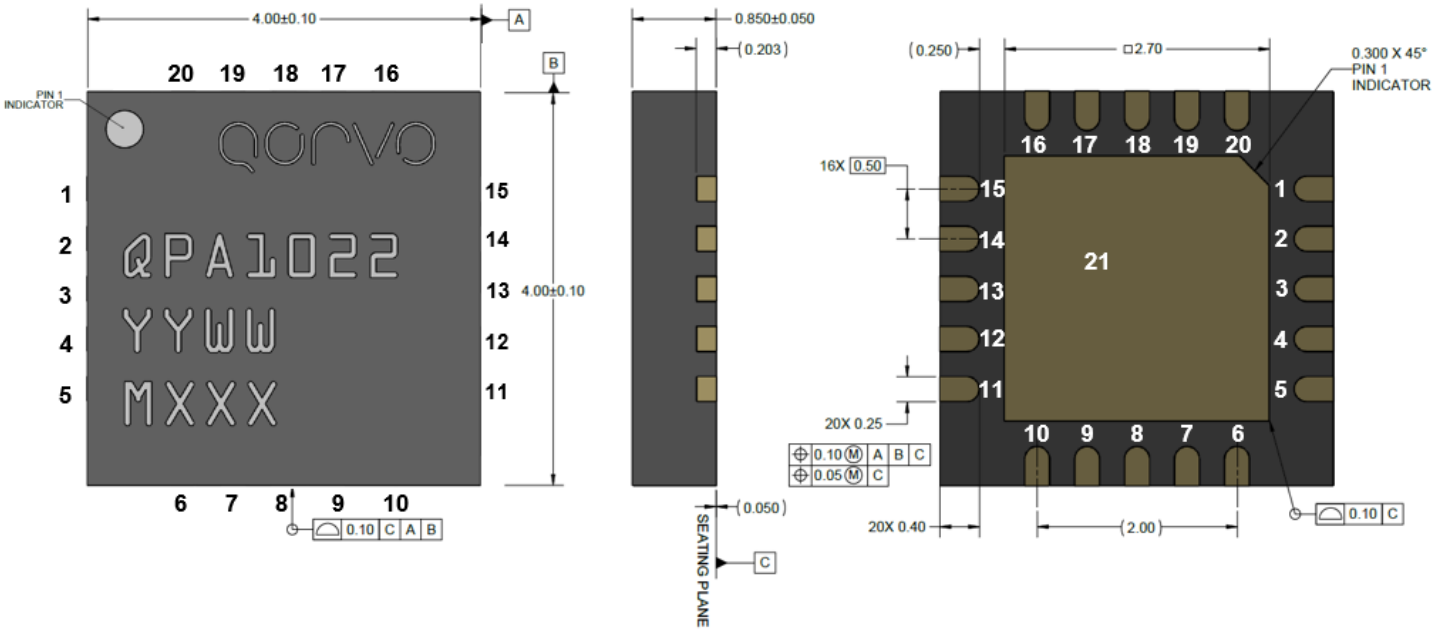
Notes:
1. Thermal resistance is referenced to the back of Cu-Mo carrier plate, assuming carrier thickness 20 mils, eutectic die attachment, back side of carrier temperature at 85 ºC
2. Refer to the following document: GaN Device Channel Temperature, Thermal Resistance, and Reliability Estimates

Dissipated Power under RF Drive

Test conditions otherwise noted: V_D = 22 V, I_{DQ} = 180 mA, CW, Temperature = +85 °C



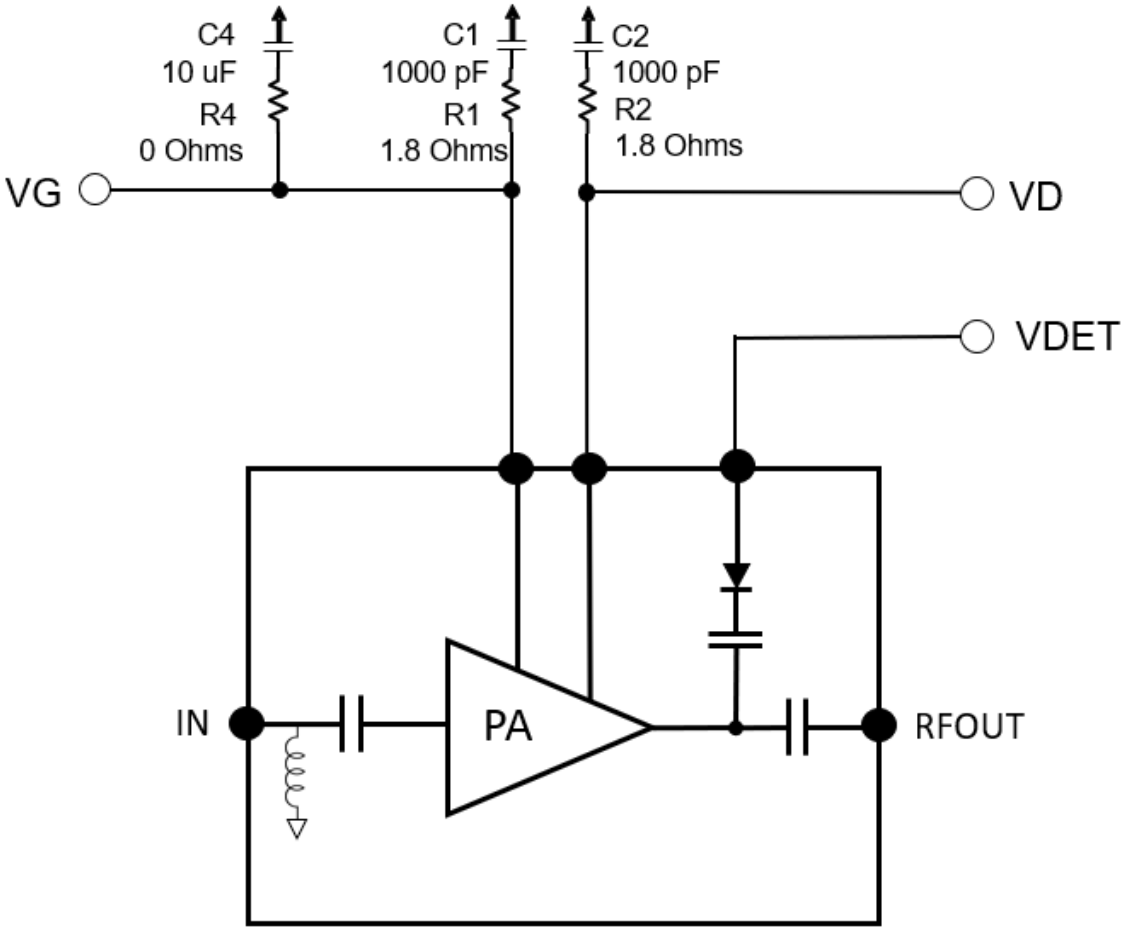
Mechanical Drawing & Pad Description



Dimensions in mm, package is mold encapsulated with NiPdAu plated leads
Part Marking: QPA1022: Part Number, YY = Part Assembly Year, WW = Part Assembly Week, MXXX = Batch ID

Pin Number	Label	Description
1, 2, 4-12, 14, 15, 18, 20	N/C	No internal connection. Recommend to GND at the PCB level
3	RF Input	Matched to 50 ohms, DC Grounded
13	RF Output	Matched to 50 ohms, DC blocked
16	VDET	Power detection, bias not required
17	VD	Drain voltage. Bypass network required.
19	VG	Gate voltage. Bypass network required.
21 (slug)	GND	GROUND

Applications Information



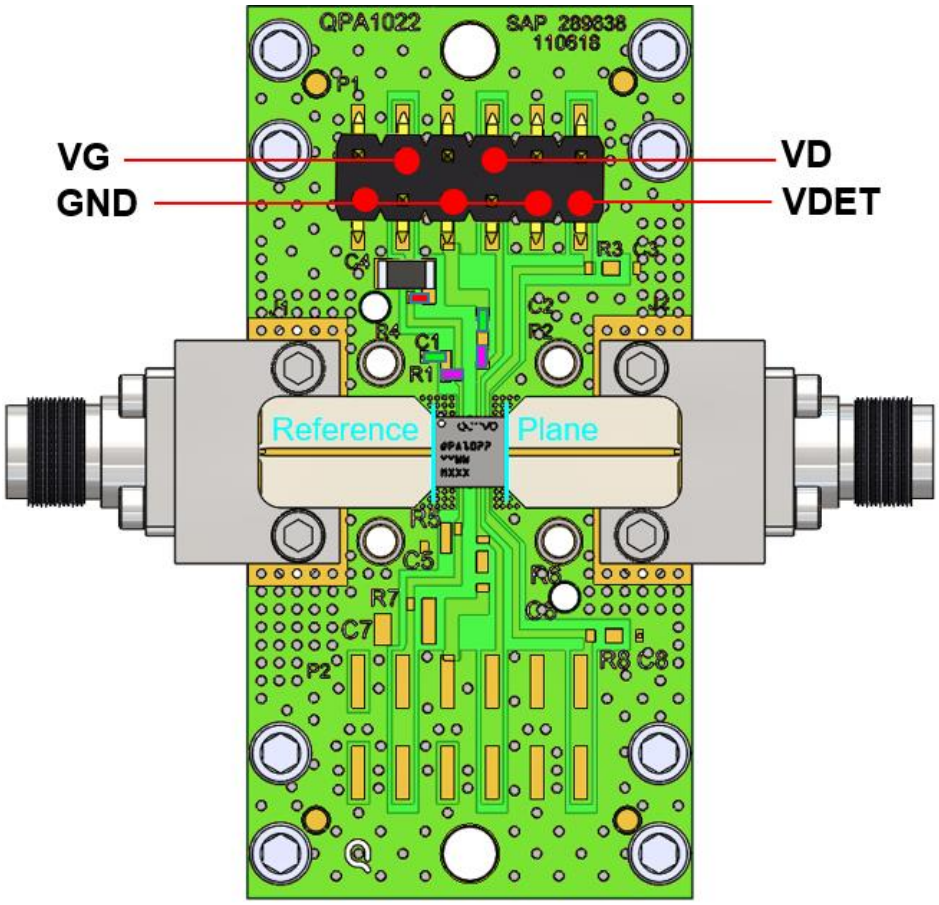
Bias-Up Procedure

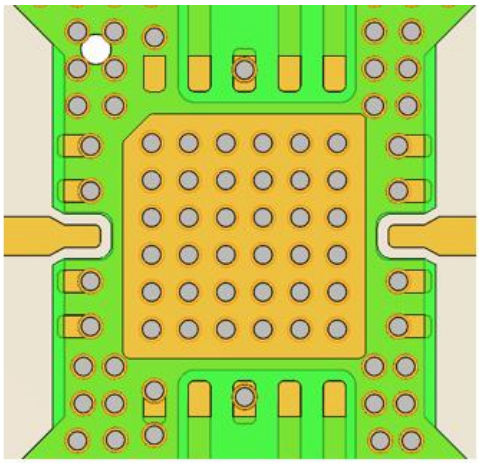
1. Set I_D limit to 600 mA, I_G limit to 10 mA
2. Set V_G to −4.0 V
3. Set V_D +22 V
4. Adjust V_G more positive until $I_{DQ} \approx 180$ mA
5. Apply RF signal

Bias-Down Procedure

1. Turn off RF signal
2. Reduce V_G to −4.0 V. Ensure I_{DQ} ~ 0 mA
4. Set V_D to 0 V
5. Turn off V_D supply
6. Turn off V_G supply

Evaluation Board (EVB) Layout Assembly





PCB Mounting Pad Details

PCB is made from Rogers 4003C dielectric, 8 mil thickness, 0.5 oz. copper both sides.

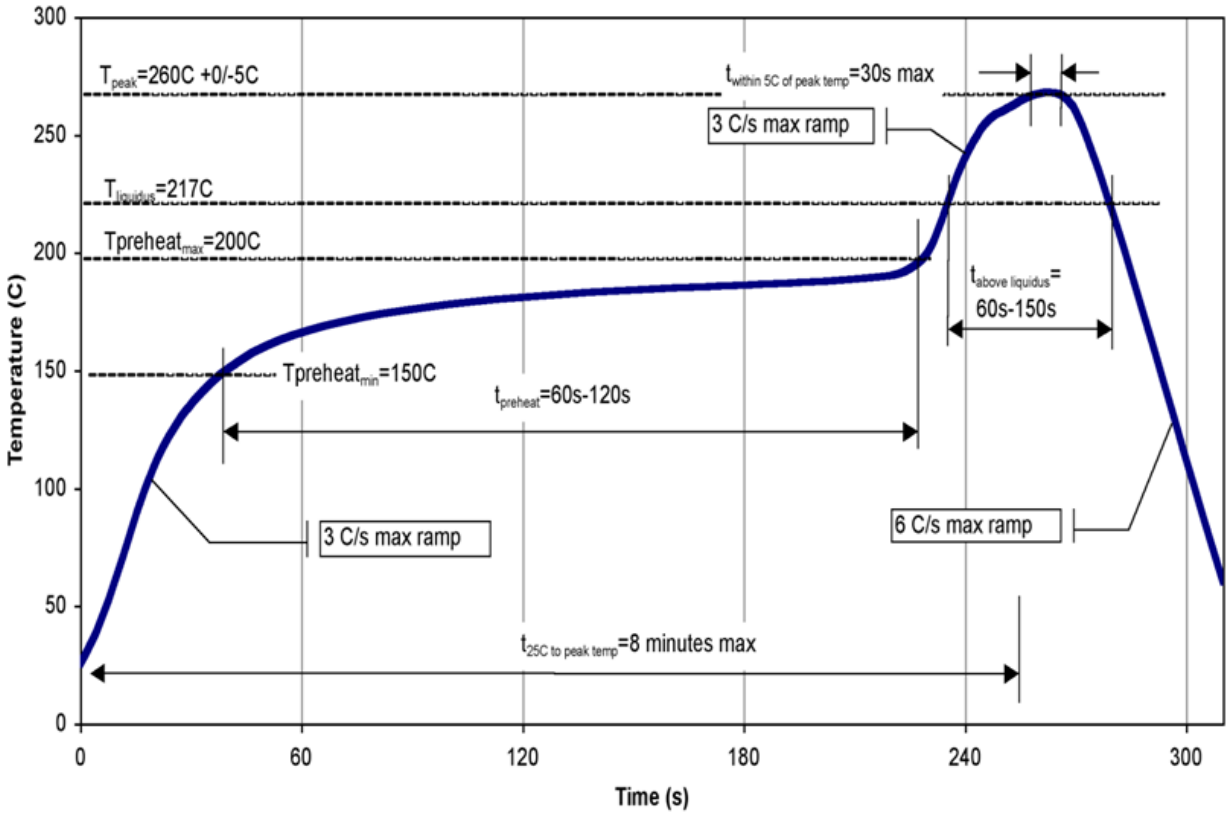
Bill of Materials

Reference Des.	Value	Description	Manuf.	Part Number
C1, C2	1000 pF	CAP, 1000 pF, 20%, 50 V, 0402	Various	
R1, R2	1.8 Ohm	RES, 1.8 Ohm, 5%, 1/10 W, 0402	Various	
C4	10 uF	CAP, 10 uF, 20%, 50 V, 1206	Various	
R4	0 Ω	RES, 0 OHM, JMPR, 0402	Various	
J1, J2	2.92 mm	CONNECTOR, FEMALE, ENDLAUNCH	Southwest Microwave	1092-01A-5

Solderability

1. Compatible with the latest version of J-STD-020, Lead-free solder, 260 °C peak reflow temperature.

Recommended Soldering Temperature Profile



Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	1B	ESDA / JEDEC JS-001-2012
ESD – Charged Device Model (CDM)	C3	ESDA / JEDEC JS-002-2014
MSL – Convection Reflow 260 °C	3	JEDEC standard IPC/JEDEC J-STD-020

Caution!

ESD-Sensitive Device

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A ($C_{15}H_{12}Br_4O_2$) Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

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